MURD340T4G, NRVUD340T4G, NRVUD340T4G-VF01

Switch-mode Power Rectifier

DPAK Surface Mount Package

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- Low Forward Voltage Drop
- Low Leakage
- Ultra-Fast Recovery Time
- NRVUD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|----------------------------------|-------------|------|
| Peak Reverse Voltage | V _R | 400 | V |
| Average Rectified Forward Current | I _{F(AV)} | 3 | Α |
| Nonrepetitive Peak Surge Current | I _{FSM} | 75 | Α |
| Operating Junction and Storage Temperature Range | T _{J,} T _{stg} | -55 to +175 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



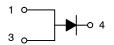
ON Semiconductor®

www.onsemi.com

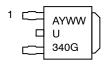
ULTRAFAST RECTIFIER 3 A, 400 V



DPAK CASE 369C



MARKING DIAGRAM



U340 = Specific Device Code A = Assembly Location*

Y = Year WW = Work Week G = Pb-Free Package

* The Assembly Location Code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

ORDERING INFORMATION

| Device | Package | Shipping [†] | |
|----------------------|-------------------|------------------------|--|
| MURD340T4G | DPAK (Pb-Free) | 2,500 / Tape & Reel | |
| NRVUD340T4G | DPAK (Pb-Free) | 2,500 / Tape & Reel | |
| NRVUD340T4G- VF01 | DPAK (Pb-Free) | 2,500 / Tape & Reel | |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MURD340T4G, NRVUD340T4G, NRVUD340T4G-VF01

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Thermal Resistance – Junction–to–Case | $R_{	heta JC}$ | 2 | °C/W |
| Thermal Resistance – Junction–to–Ambient (Note 1) | $R_{\theta JA}$ | 49 | °C/W |

^{1.} Rating applies when surface mounted on a 700 mm², 1 oz Cu heat spreader.

ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--|-----------------|-----------------|------|
| Maximum Instantaneous Forward Voltage ($I_F = 3.0 \text{ A}, T_J = 25^{\circ}\text{C}$) ($I_F = 3.0 \text{ A}, T_J = 150^{\circ}\text{C}$) | V _F | 1.15 0.92 | V |
| Maximum Instantaneous Reverse Current (Rated V_R) $(T_J = 25^{\circ}C, 400 \text{ V})$ $(T_J = 150^{\circ}C, 400 \text{ V})$ | I _R | 5 500 | μΑ |
| Maximum Reverse Recovery Time (I _F = 1.0 A, di/dt = 50 A/ μ s, V _R = 30 V, T _J = 25°C) | t _{rr} | 50 | ns |
| ESD Ratings: Machine Model = C Human Body Model = 3B | | > 400 > 8000 | V |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

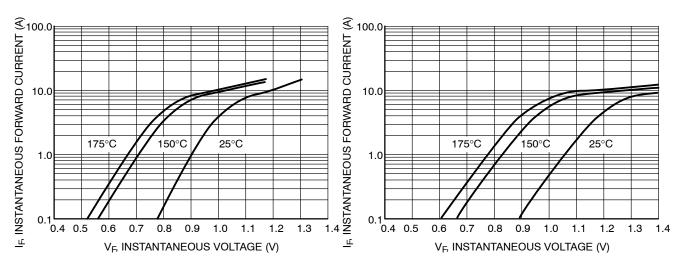


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

MURD340T4G, NRVUD340T4G, NRVUD340T4G-VF01

TYPICAL CHARACTERISTICS

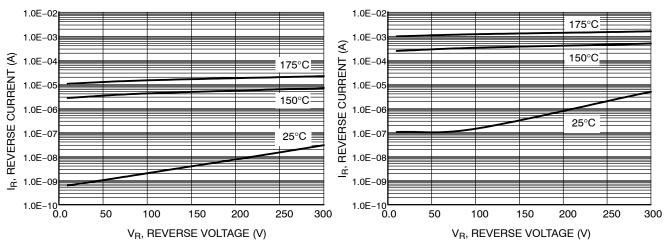
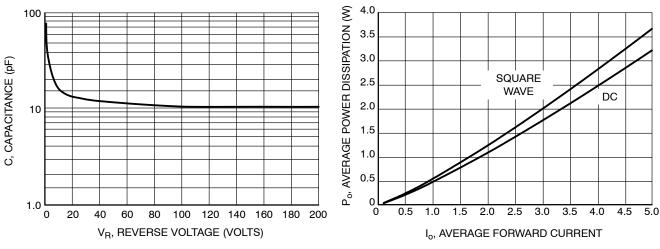


Figure 3. Typical Reverse Voltage

Figure 4. Maximum Reverse Voltage



DC

SQUARE

WAVE

150

160

170

Figure 5. Typical Capacitance

6.0

5.0

4.0

3.0

2.0

1.0

100

 $R_{\theta JC} = 2^{\circ}C/W$

 $T_J=175^{\circ}C/W$

110

120

130

IF, AVERAGE FORWARD CURRENT (A)

6.0 I_F, AVERAGE FORWARD CURRENT (A) $R_{\theta JC} = 2^{\circ}C/W$ 5.0 $T_{.J} = 175^{\circ}C/W$ 4.0 DC 3.0 **SQUARE** 2.0 WAVE 1.0 0 180 20 100 120 140 TA, AMBIENT TEMPERATURE (°C)

Figure 6. Power Dissipation

 T_C , CASE TEMPERATURE (°C) Figure 7. Current Derating, Case

140

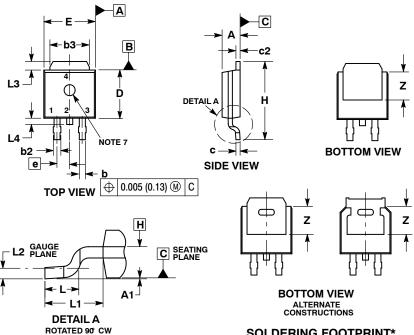
Figure 8. Current Derating, Ambient

MURD340T4G, NRVUD340T4G, NRVUD340T4G-VF01

PACKAGE DIMENSIONS

DPAK (SINGLE GAUGE)

CASE 369C **ISSUE F**



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
- Y14.5M, 1994.

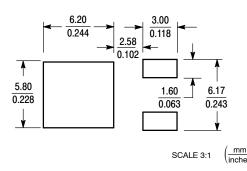
 2. CONTROLLING DIMENSION: INCHES.

 3. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3 and Z.

 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD
- FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
- DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 6. DATUMS A AND B ARE DETERMINED AT DATUM
- 7. OPTIONAL MOLD FEATURE.

| | INCHES | | MILLIMETERS | | |
|-----|-----------|-------|-------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.086 | 0.094 | 2.18 | 2.38 | |
| A1 | 0.000 | 0.005 | 0.00 | 0.13 | |
| b | 0.025 | 0.035 | 0.63 | 0.89 | |
| b2 | 0.028 | 0.045 | 0.72 | 1.14 | |
| b3 | 0.180 | 0.215 | 4.57 | 5.46 | |
| С | 0.018 | 0.024 | 0.46 | 0.61 | |
| c2 | 0.018 | 0.024 | 0.46 | 0.61 | |
| D | 0.235 | 0.245 | 5.97 | 6.22 | |
| E | 0.250 | 0.265 | 6.35 | 6.73 | |
| е | 0.090 BSC | | 2.29 BSC | | |
| Н | 0.370 | 0.410 | 9.40 | 10.41 | |
| L | 0.055 | 0.070 | 1.40 | 1.78 | |
| L1 | 0.114 REF | | 2.90 REF | | |
| L2 | 0.020 | BSC | 0.51 BSC | | |
| L3 | 0.035 | 0.050 | 0.89 | 1.27 | |
| L4 | | 0.040 | | 1.01 | |
| Z | 0.155 | | 3.93 | | |

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages.

Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Phone: 81-3-5817-1050